ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INTERNATION	<b>Composition De</b> 2005. IPC, Bannockt and Pan-American co	c <b>laration</b> ourn, Illinois. A opyright conver	Il rights reserved u ntions.	nder both	This docume level parts, tl	ent is a declaration er	on of the substance acompasses all lo	es within the m wer level mater	anufacturer lis als for which t	ted item. Note: if he manufacturer	the item is an a has engineering	ssembly with low responsibility.	
				Form Type Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				us Materials ar	als and Mfg Information			
upplier Information													
ompany name*	Company unique ID			τ	Unique ID Authority				Response Date*				
nsemi									2024-05-05				
ontact Name	Title - Contact			1	Phone - Contact*				Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance				NA			Pro	Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Representative			1	Phone - Representative*			Em	Email - Representative*				
roduct-Env-Stewards	Product Enviro Compliance				NA			Pro	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	Number	nber Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	FSBB10	FSBB10CH120D SPM3V		PM3V INV 1200V 10A		2024-05-05		СРА		16491.803	mg	Each	
Ianufacturing Proccess In	formation												
Terminal Plating / Grid A	Terminal Plating / Grid Array Material Terminal H		e Alloy J-STD-020 MSL R		Rating	Peak Process Body Temperatur		ture Max Tim	e at Peak Tem	perature Number	er of Reflow Cy	cles	
Matte Tin (Sn) - annealed		CU Alloy NA		NA		0	C	30	s	econds 3			
omments													
or more information regarding n	naterial composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
DBC	1880.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		752	mg
			Supplier	Copper (Cu)	7440-50-8		1128	mg
Die	67.7	mg	Supplier	Silicon (Si)	7440-21-3		67.7	mg
Die Attach	31.4	mg	Supplier	Silver (Ag)	7440-22-4		0.785	mg
			Supplier	Tin (Sn)	7440-31-5		29.045	mg
			Supplier	Copper (Cu)	7440-50-8		1.57	mg
Die Attach2	0.163	mg	Supplier	Poly(oxypropylene)diamine	9046-10-0		0.0049	mg
			Supplier	Miscellaneous	Trade Secret		0.0082	mg
			Supplier	Silver (Ag)	7440-22-4		0.1386	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0114	mg
Lead Frame	4318.38	mg	Supplier	Silver (Ag)	7440-22-4		1.47	mg
			Supplier	Iron (Fe)	7439-89-6		5.18	mg
			Supplier	Copper (Cu)	7440-50-8		4309.998	mg
			Supplier	Phosphorus (P)	7723-14-0		1.73	mg
Mold Compound-Black	10122.0	mg	Supplier	Polymer(phenyl glycidil ether)-co- dicyclopentadiene	119345-05-0		404.88	mg
			Supplier	4,4'-Bis(2,3-epoxypropoxy)-3,3',5,5'- tetramethylbiphenyl	85954-11-6		404.88	mg
			Supplier	Carbon Black (C)	1333-86-4		50.61	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		8755.5303	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		101.22	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		404.88	mg
Plating	53.3	mg	Supplier	Tin (Sn)	7440-31-5		53.3	mg
Wire Bond - Al	18.3	mg	Supplier	Aluminum (Al)	7429-90-5		18.3	mg
Wire Bond - Cu	0.56	mg	Supplier	Copper (Cu)	7440-50-8		0.56	mg